



# Photon/particle to Digital Converter

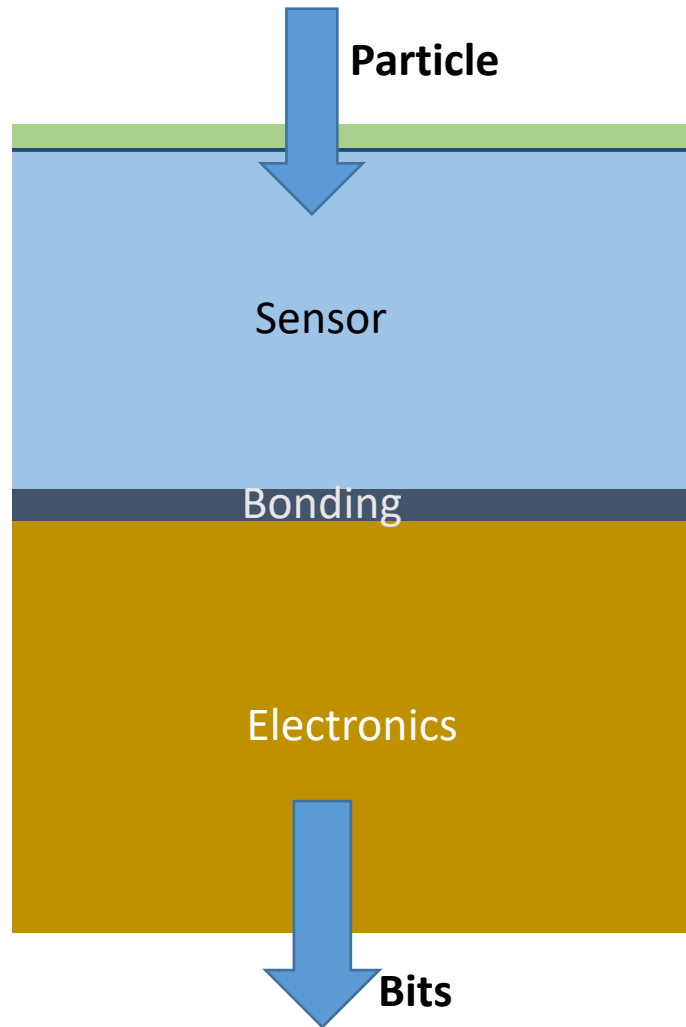
Fabrice Retière (TRIUMF)

For the PDC group



Discovery,  
accelerated

# Concept. What is a PPDC?



- Particle = photon, Minimum ionizing particle, heavy ionizing particle,...
- Integrated system for sensing particle and generating digital data
- Two options
  - Monolithic, i.e. fully integrated
    - Thin, but forces drastic compromises
  - **Separate sensing and electronics features: this talk**

# Outline

- Enable groundbreaking Discovery
- Physics meets technology
- Well connected and nibble
- Building a better world

# Enabling ground-breaking discovery

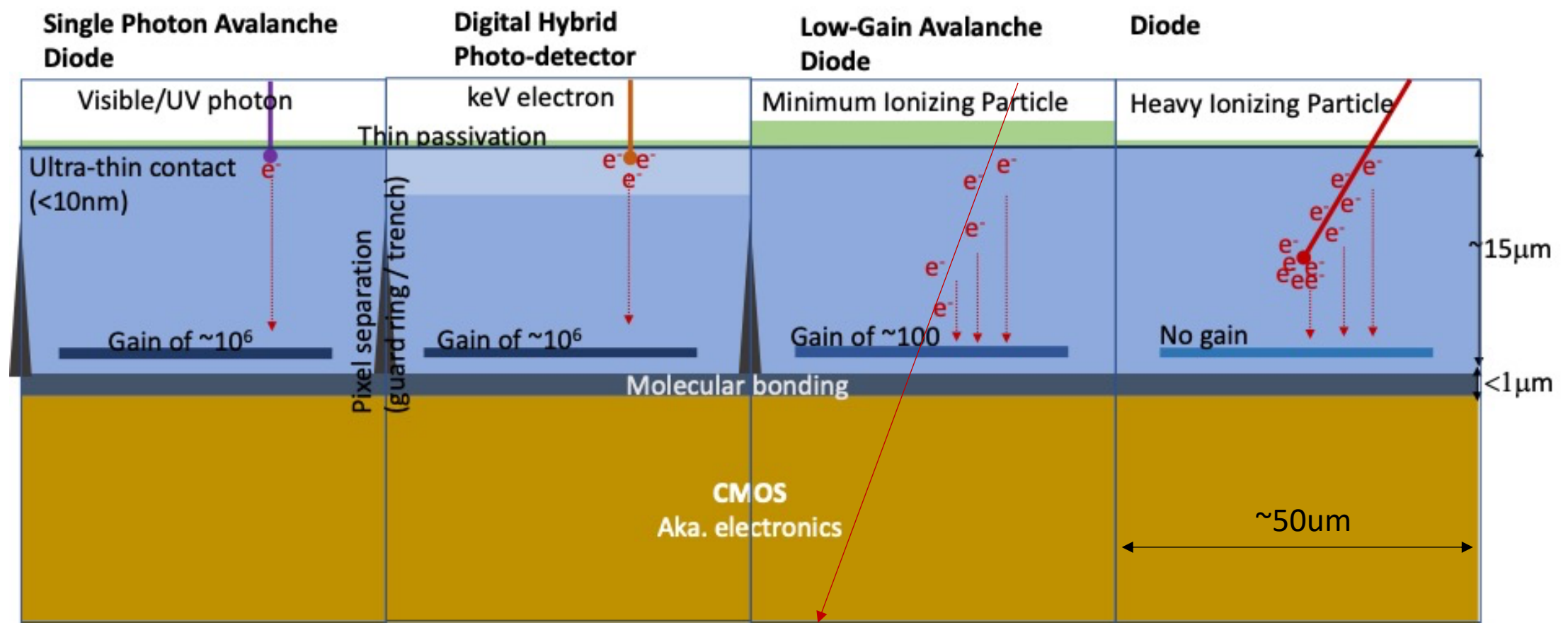
- Neutrinos
  - Hyper-Kamiokande - large area photon detection (350-500nm – room T)
  - DUNE - large area photon detection in Liquid Argon (128nm/420nm - 86K)
  - nEXO – large area photon detection in liquid Xenon (175nm – -100C)
  - P-ONE/IceCUBE
- Direct dark Matter detection
  - ARGO
  - DARWIN
- Colliders – Minimum ionizing particle
  - Tracking – radiation hard, low mass, high timing resolution
- Nuclear physics
  - Heavy ionizing particle detection
- $\mu$ SR – the pico-second era



# Performances – the picosecond era is here

- Picosecond scale  $\sim$  mm scale
  - Digital integration enable managing jitters down to 10ps and probably 1ps
- Good for physics?
  - Identify each collision at the LHC – handle pile-up in high luminosity era
    - $\sim$ 1 vertex/interaction per mm at high-luminosity LHC
  - uSR with plastic scintillator or ps-tracking detectors?
  - Gamma ray detection. Is there a fast-enough scintillator?
    - Pico-second scale is the holly grail for positron emission tomography
  - Cerenkov light – fast enough but not very bright
    - Compelling at GeV scale
  - Very fast excitation – de-excitation processes?
    - Femtosecond laser for measuring picosecond decay process?

# Technology scope

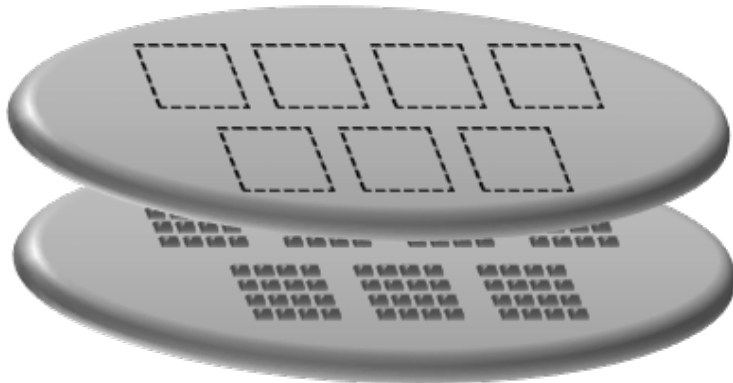


# Building such an object – The Sherbrooke – DALSA partnership

Partnership with Teledyne DALSA Semiconductor Inc.  
(Bromont QC, Canada)



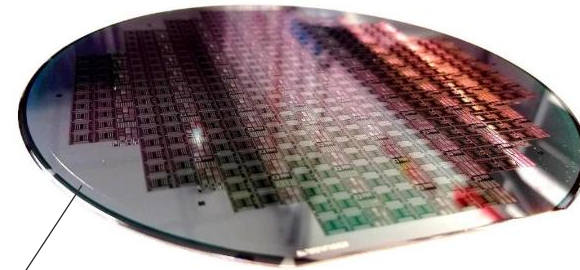
Wafer scale 3D digital SiPM technology



SPAD array layer

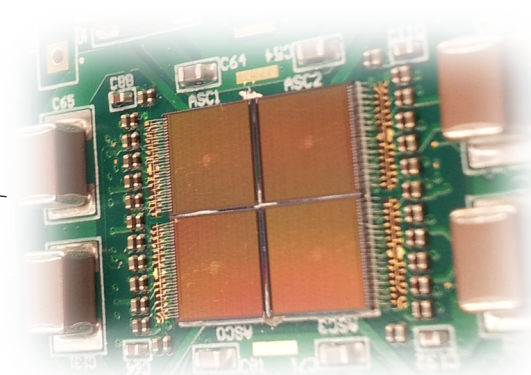
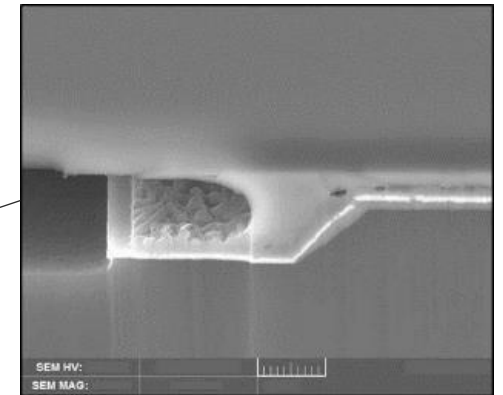
Wafer level process

CMOS readout



SPAD process

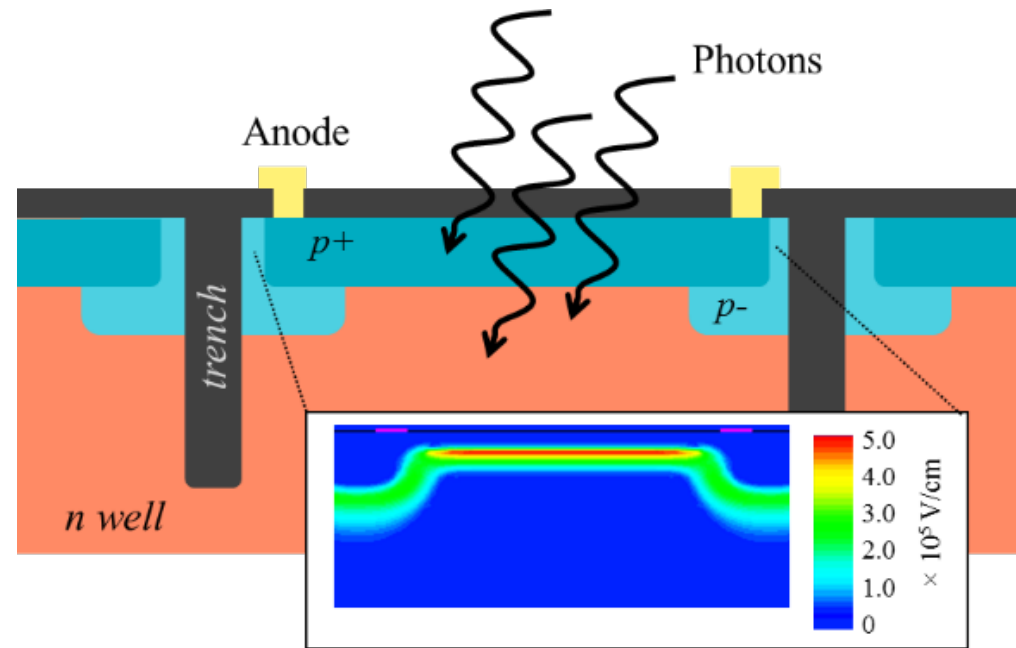
3D process



TSMC CMOS readout August 20 2020

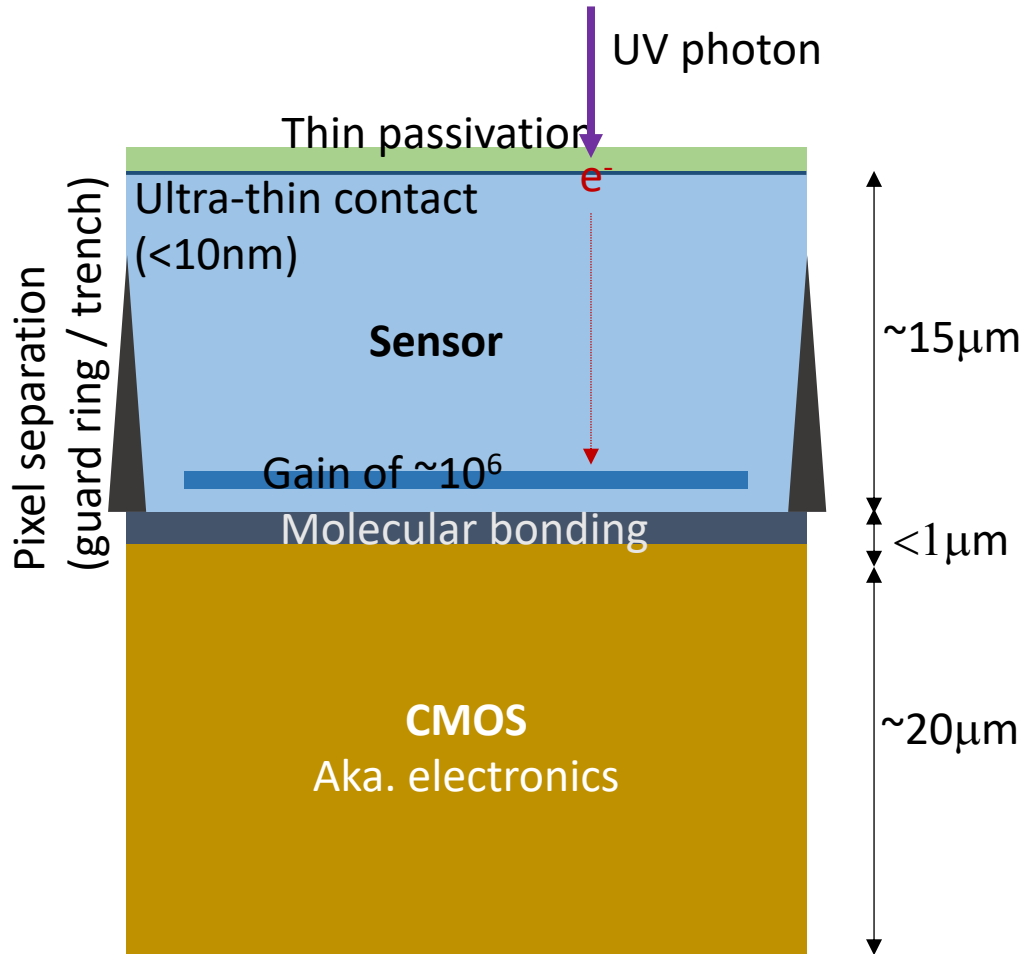
# Sensor layer

- Current Single Photon Avalanche Diode (SPAD) concept
  - Front side illuminated photon sensor
  - UdeS design manufactured at TDSI
- Back-side illuminated concept
  - Efficiency >50% expected from 150nm to 700nm
    - Even pushing further in IR



- Beyond photon detection
  - Low gain avalanche diode
    - Very similar to SPADs
    - At LHC, radiation hardness is key
    - But what about  $\mu$ SR or nuclear physics usage (ISAC, EIC)?
  - Other materials such as GaN
    - Thomas Koffas's talk

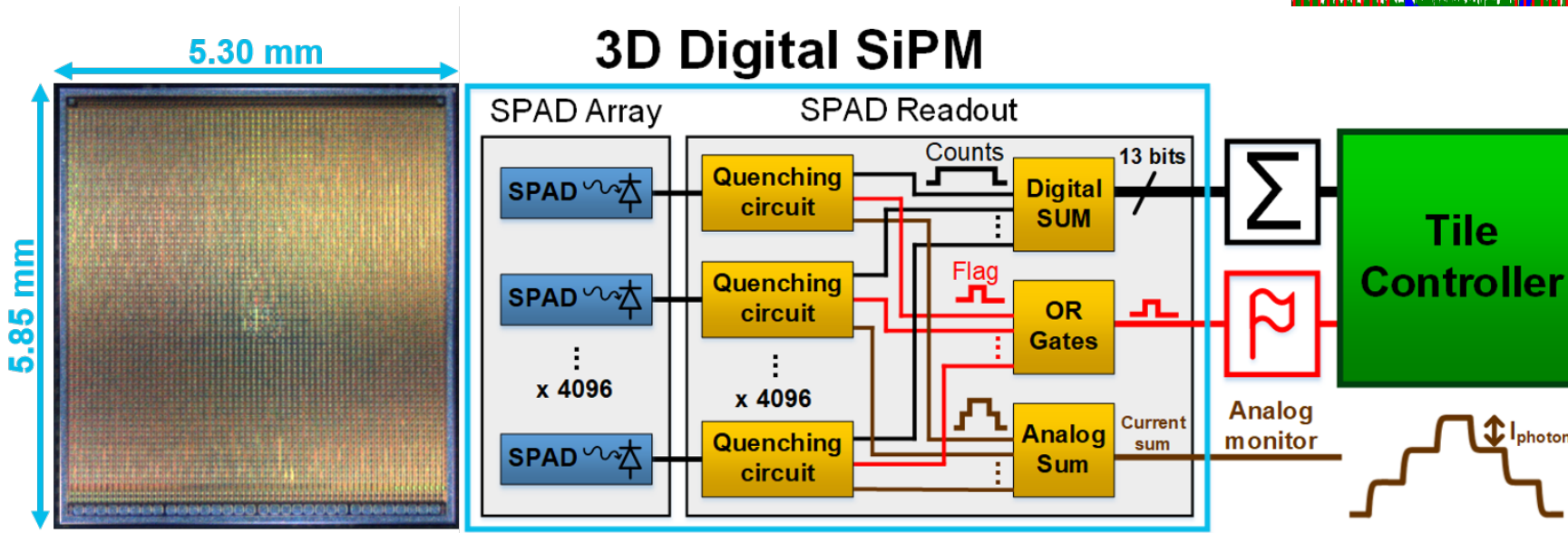
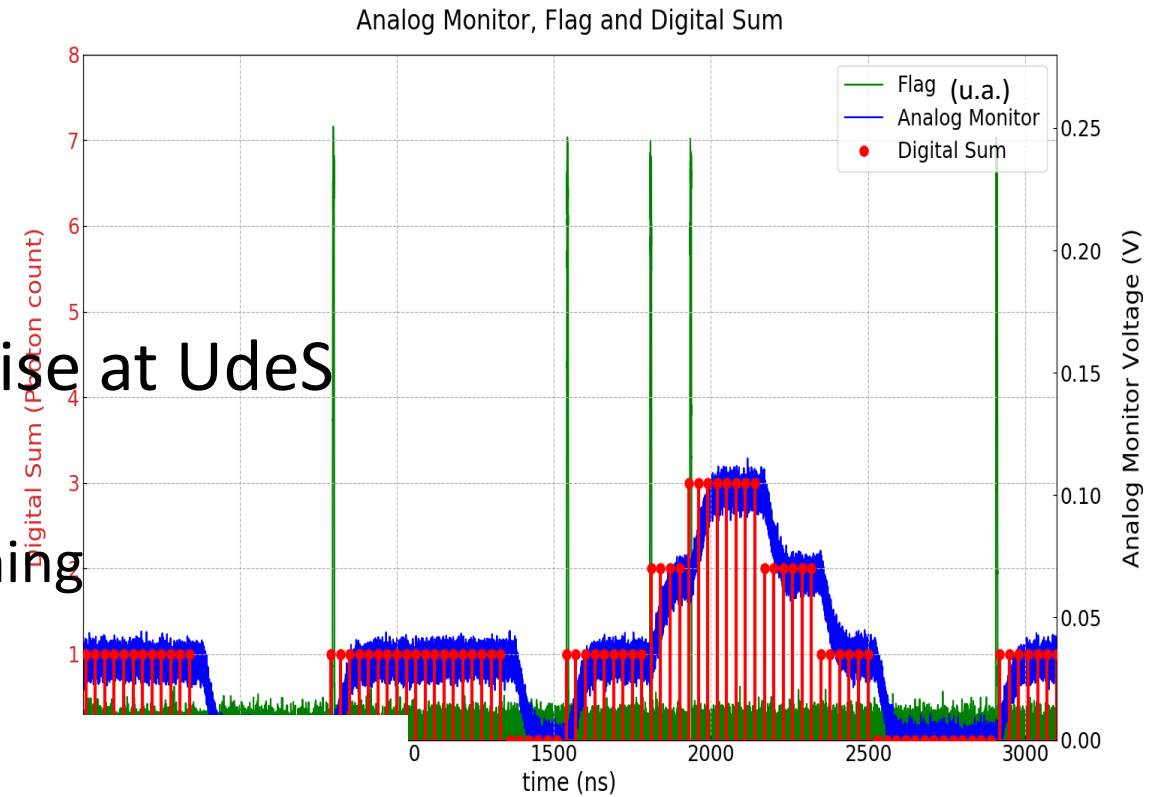
# Back-side illuminated concept



- TRIUMF's contributions
  - Design (Gallina - PhD)
  - Measurement and management of light emitted by SiPM (McLaughlin - PhD, Xie - *Msc*)
- Sensor manufacturing
  - DALSA line busy with front illuminated
    - Investigating other options
  - Require post bonding thinning
    - Investigating option of doing that at Teledyne-e2v (UK) – collaboration with J.Monroe at RHUL

# Electronics layer

- Already very mature - outstanding expertise at UdeS
- Based on conventional CMOS technology
  - Essentially ASIC design with focus on fast timing



# Bonding the two together

- Current technology: AlGe bonding, essentially bump bonding
- Next technology: molecular bonding
  - Pros: very strong bond enabling post bond thinning
  - Pros: scalable to 8-12" wafers
  - Cons: require extreme flatness of CMOS and sensor chips
  - Can be done at Teledyne-DALSA with some upgrade



# Being nibble - 3DdSiPM → PDC → PPDC

- Technology pioneered by U.de Sherbrooke (UdeS) for photon detection
  - Original motivation was Positron Emission Tomography
  - Sensor and 3D assembly at Teledyne DALSA (TDSI, Bromont QC)
- TRIUMF involvement led to major investment by astro-particle physics community
  - CFI innovation fund 2017 led by M. Boulay (Carleton) with R. Kruecken (UBC lead)
  - NSERC SAP - nEXO project
  - McDonald Institute manpower support and venture funds
- Next step: a Canadian technology equipping major physics experiments
  - Major funding (10M\$ scale) still required
  - Evolution beyond astro-particle physics and photon detection required

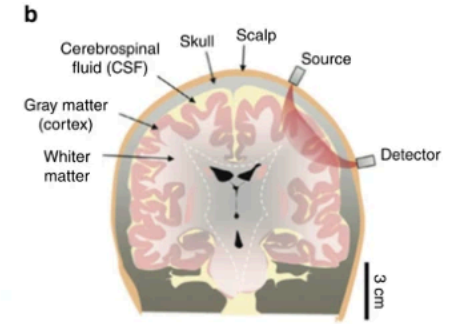
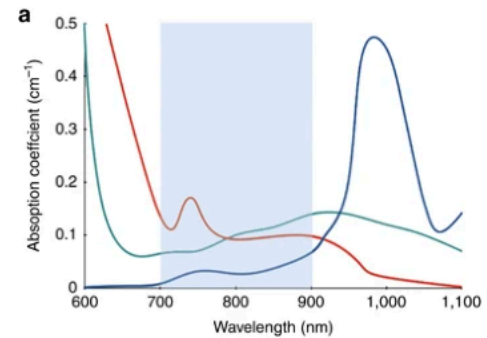
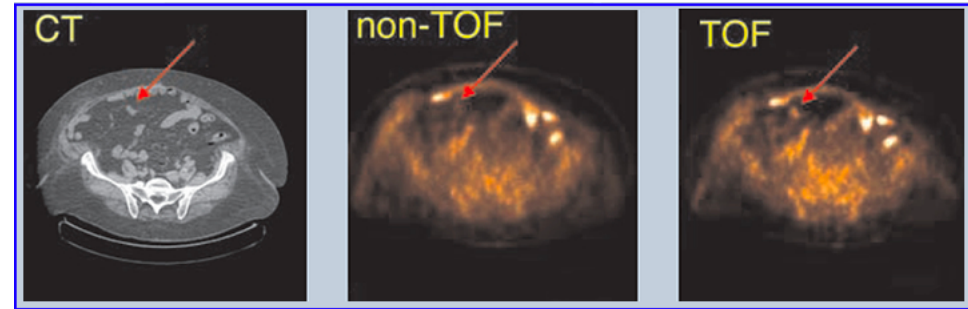


# Being nibble – being connected

- High risk – high payoff projects that Canada is not used to pursuing
  - Require ~10M\$ investment
- Funding from Canadian astro-particle physics likely to plateau at 5M\$
  - Though we are investigating establishing a UK-Canada project
    - Injection of funding from UK + participation of Teledyne-DALSA
  - Though ARGO might get major funding...
- Broadening the project scope to the Canadian SAP community
  - LGADs in the context of HL-LHC
  - Many other applications are possible
- Broadening the project scope beyond SAP, CMMS,...
- But **we need engaged partners – PPDC collaboration**
  - And we are considering joining RD50

# Building a better world – Medical imaging

- Time of Flight Positron Emission Tomography
  - 10ps coincidence timing resolution of 511keV gamma would drastically improve image quality
- Radiotherapy imaging
  - Next talk
- Diffuse optical tomography
- ***Medical doctor partners needed...***



**Diffuse optical tomography to investigate the newborn brain**

Chuen Wai Lee, Robert J Cooper & Topun Austin

*Pediatric Research* 82, 376–386(2017) | Cite this article

# Building a better world – Single Photon Air Analyzer



- Particulate (smoke) analysis in air using Mie scattering
  - And fluorescence
- Technology: VUV PDC & UV-C LED
  - Deep UV for probing sub- $\mu\text{m}$  particulate  $\rightarrow$  sensitivity & discrimination
  - Single photon enable lowest power dissipation  $\rightarrow$  portable
  - $\rightarrow$  low cost?
- Arrays of connected sensors for rapid forest fire detection in populated area or worn by first responders

# Vision for the next 20 years

- This is the coolest, most versatile technology I have ever worked on, but it is also the most expensive so can we pull it off?
- Yes, Yes, and YES,... However
  1. We need an attractive governance structure
    - Able to attract many in of you!
    - Enabling major contributions from many groups
  2. We need an efficient project management strategy
    - Must be risk mitigation oriented not schedule oriented due to R&D focus
  3. We need outstanding creativity in physics and engineering
  4. We need an efficient technology transfer strategy
- So Yes, we need TRIUMF to pull it off

# If we succeed – a 4D world

- A Canadian technology having enabled discoveries
  - In astro-particle physics
  - At HL-LHC
  - In nuclear physics
  - In  $\mu$ SR
- And helping make tomorrow a better world
- And I guess, consumer market opportunities
- A venture well worth doing – And TRIUMF is the necessary glue to make it happen

Current PI contributors

Serge Charlebois, Jean-Francois Pratte (U.Sherbrooke)

Fabrice Retière and Reiner Kruecken (TRIUMF)

Aksel Hallin [ARGO] and Juan Pablo Yanez [P-ONE/IceCube] (U. Alberta)

Mark Boulay [ARGO] and Simon Viel [ARGO, nEXO] (Carleton University)

Thomas Brunner [nEXO] (McGill)

Pietro Giampa [SBC] (TRIUMF/SNOLAB)

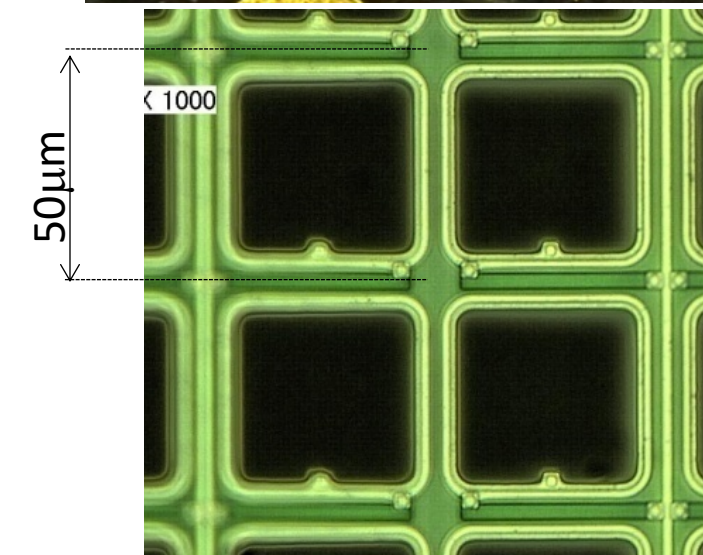
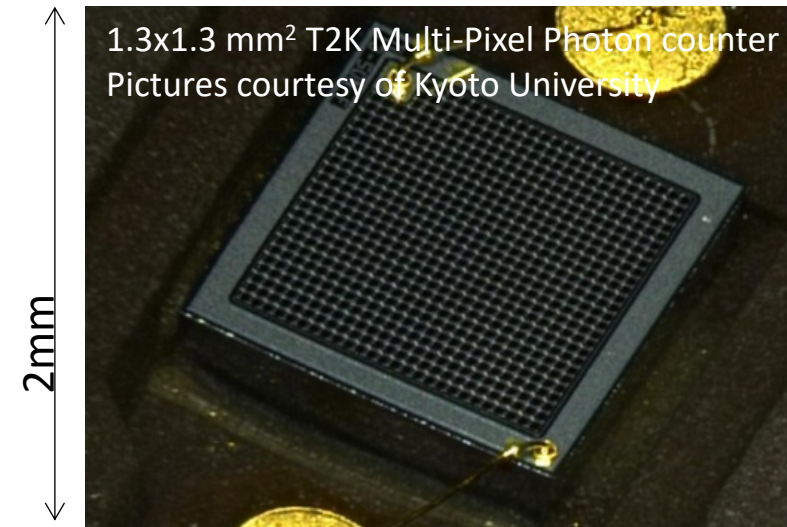
Jocelyn Monroe [ARGO] (RHUL, UK)

The end



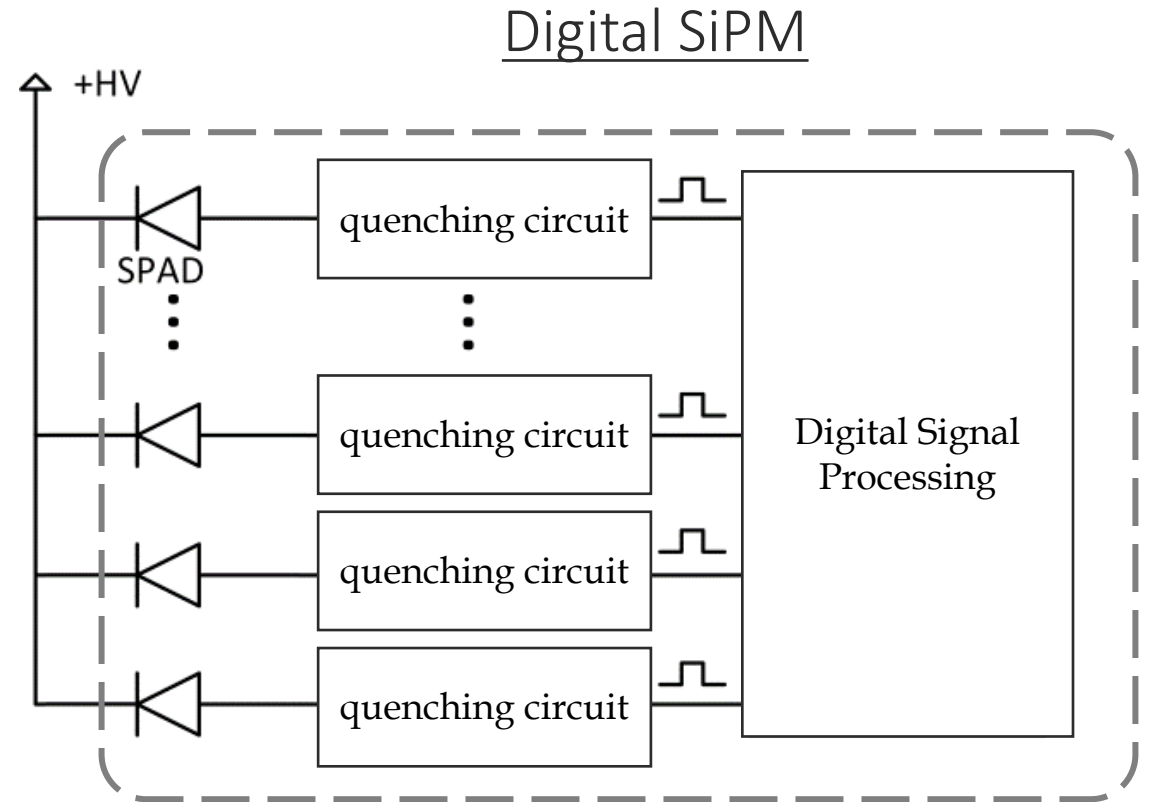
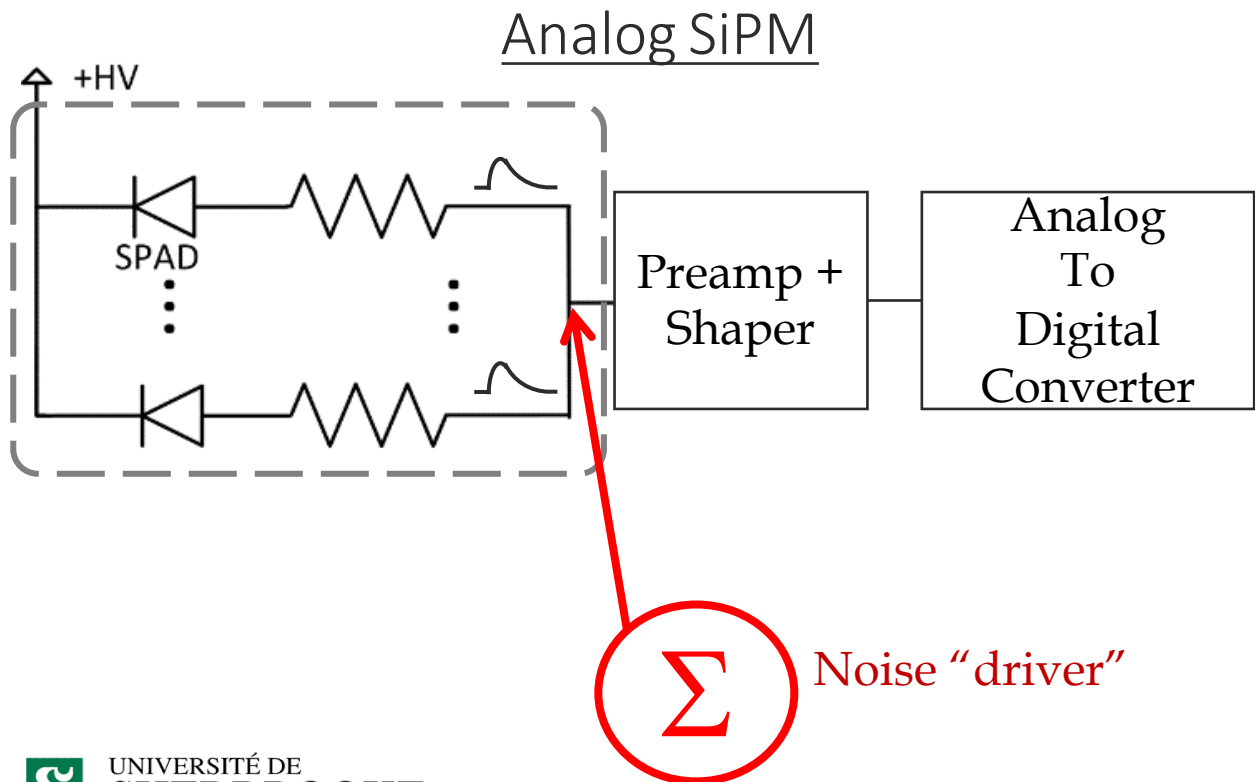
# Silicon photo-multipliers

- Single photon avalanche diode (SPAD) array
- Single photon detection capability
  - High gain
- Large manufacturing capabilities
- High efficiency
- Radiopurity
- “Low” dark noise if cold



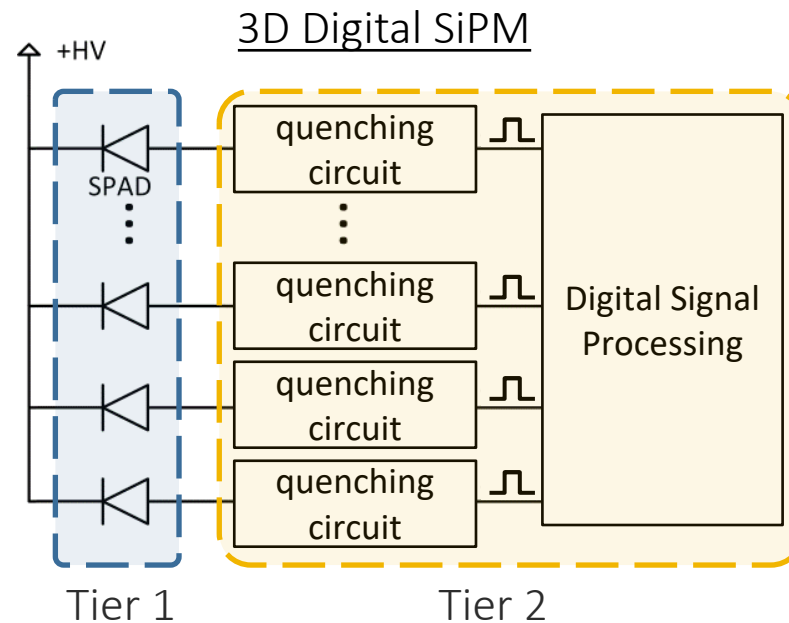
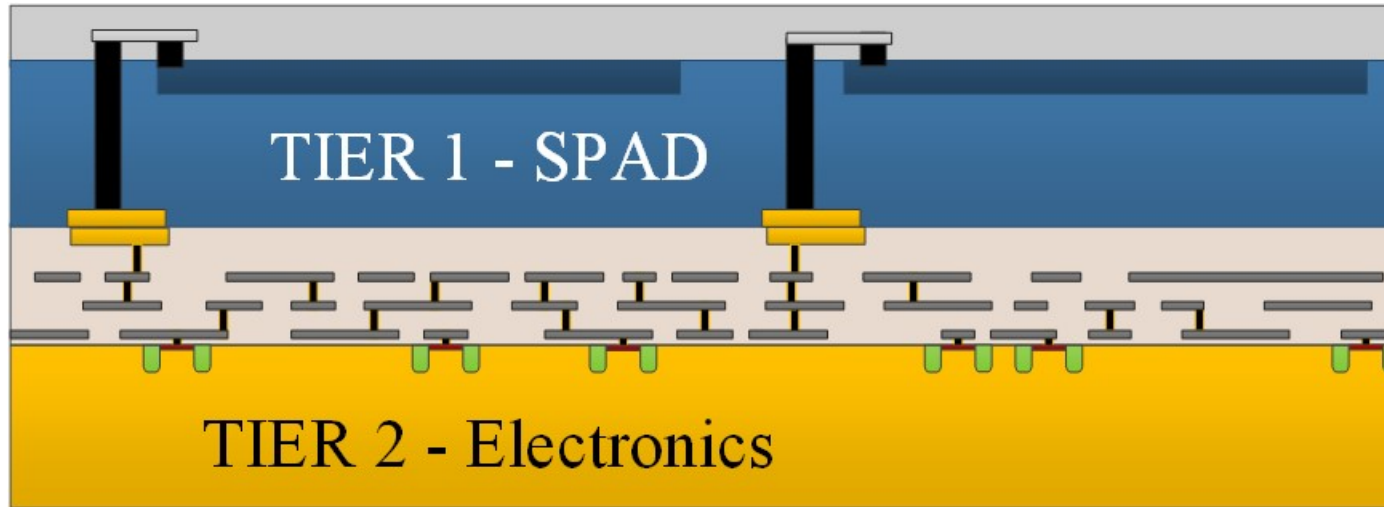
# Going digital

Single photon avalanche diode (SPAD) is the basic unit cell of analog and digital SiPM



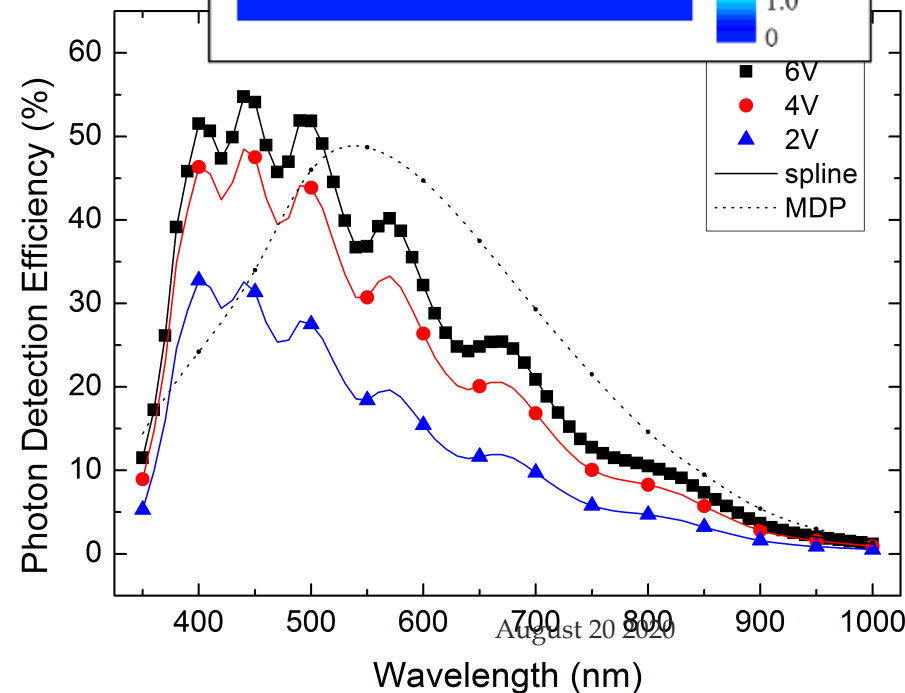
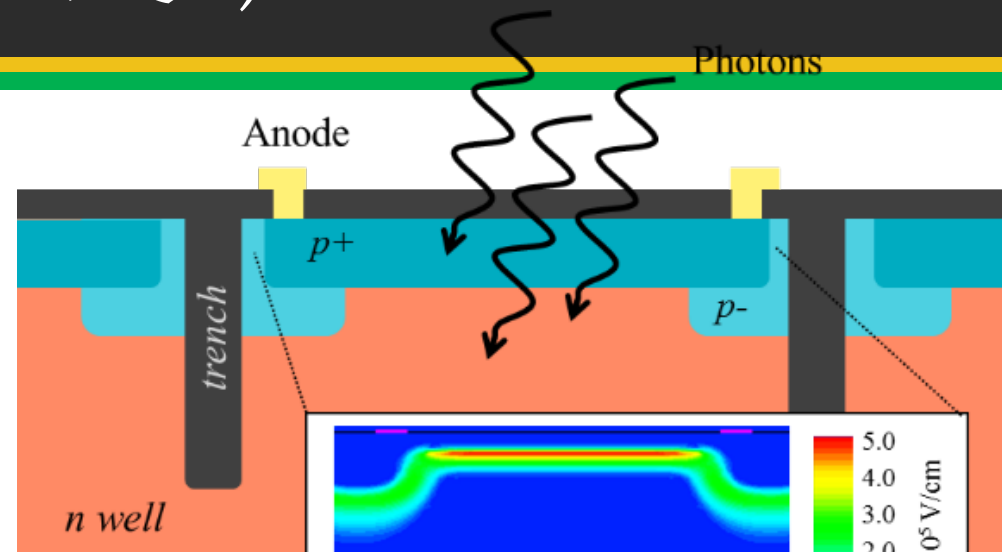
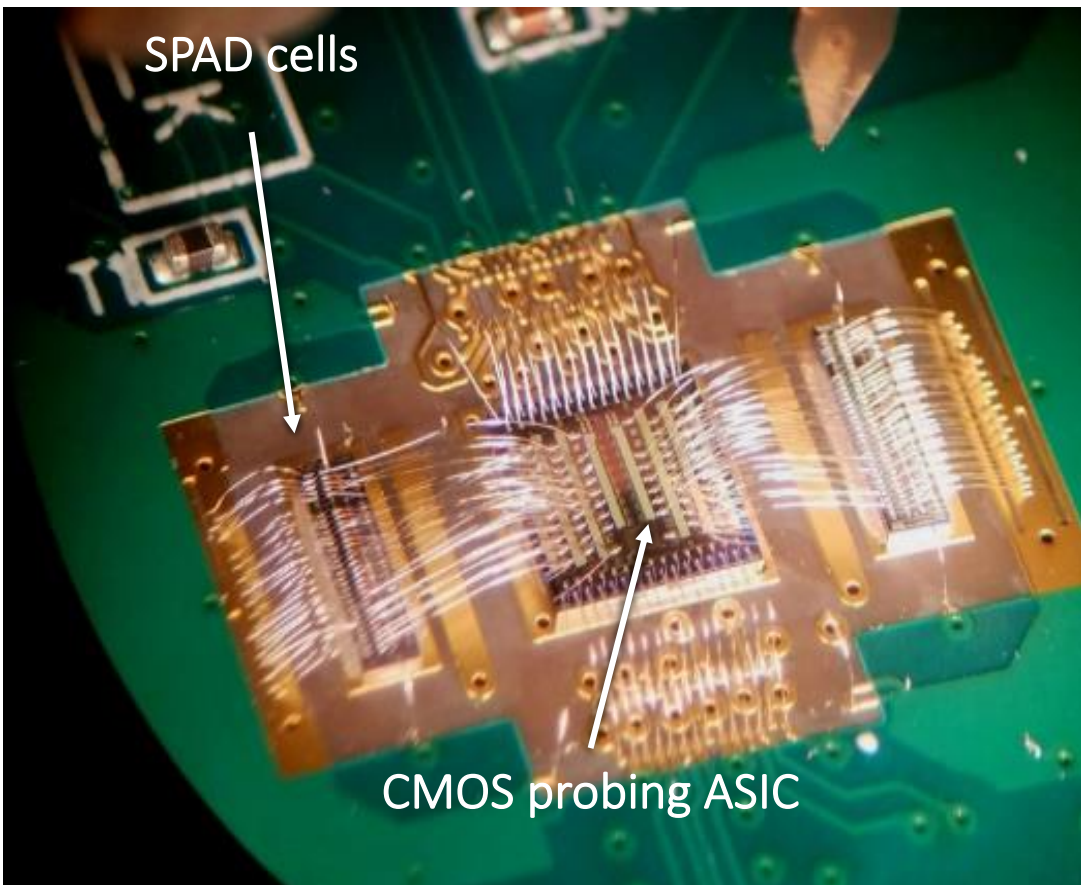


# 3D Digital SiPM / Photon-to-Digital Converter Concept

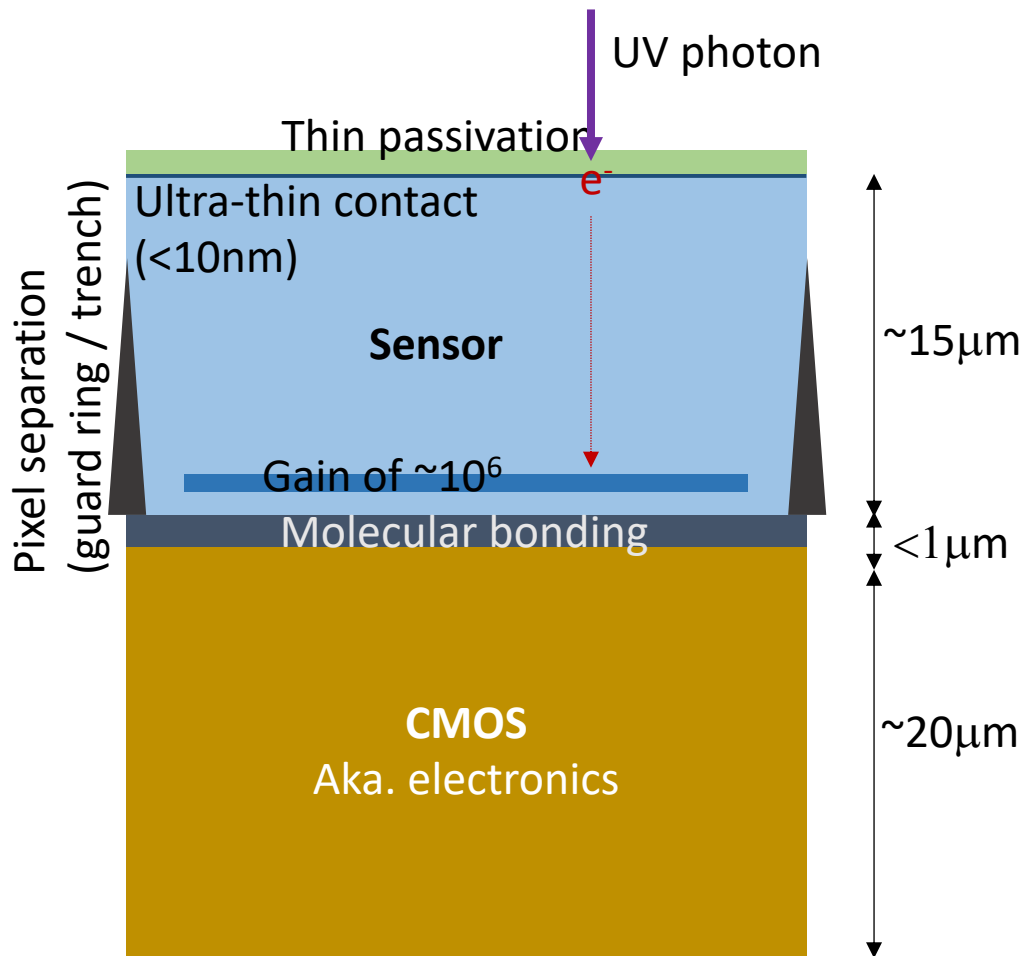


# 2D SPAD made-in Canada (Bromont, QC)

- 150 mm wafer (custom process using DALSA CCD production line)
- 1x1 to 5x5 mm<sup>2</sup> SPAD array

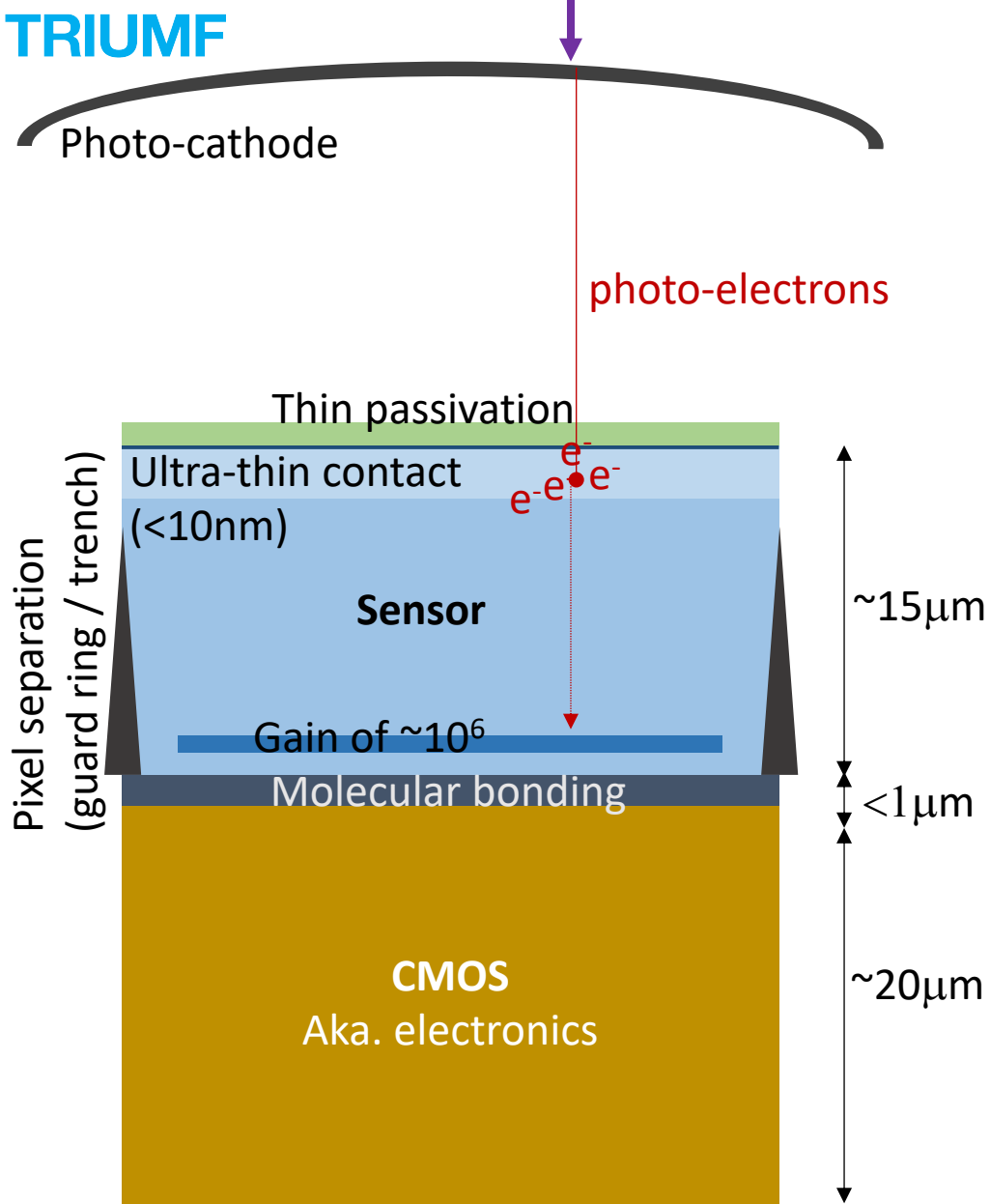


# Hybrid solution for UV (120-400nm) photon



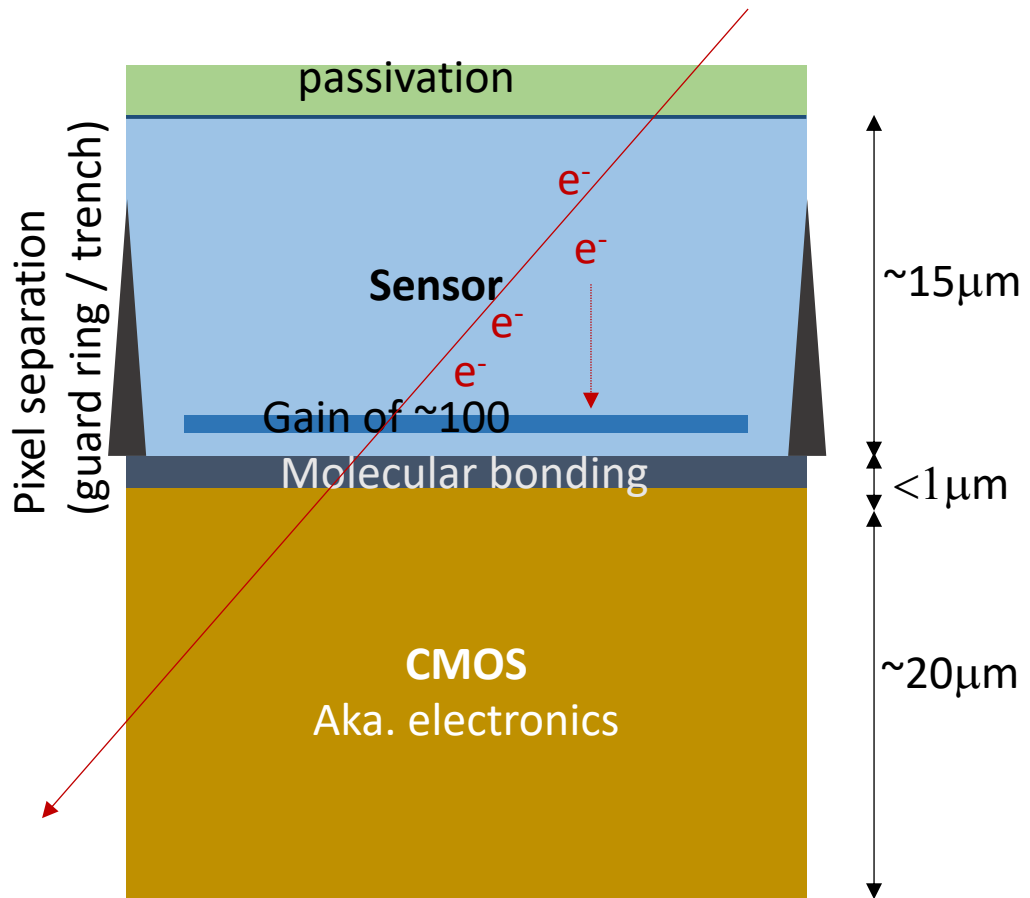
- Single photon avalanche diode
  - Gain >  $10^5$
- Advantages
  - Very high efficiency expected (>50%) in UV and visible
  - Single photon timing resolution <50ps
- Back-Side illuminated concept require significant R&D

# Beating down dark noise



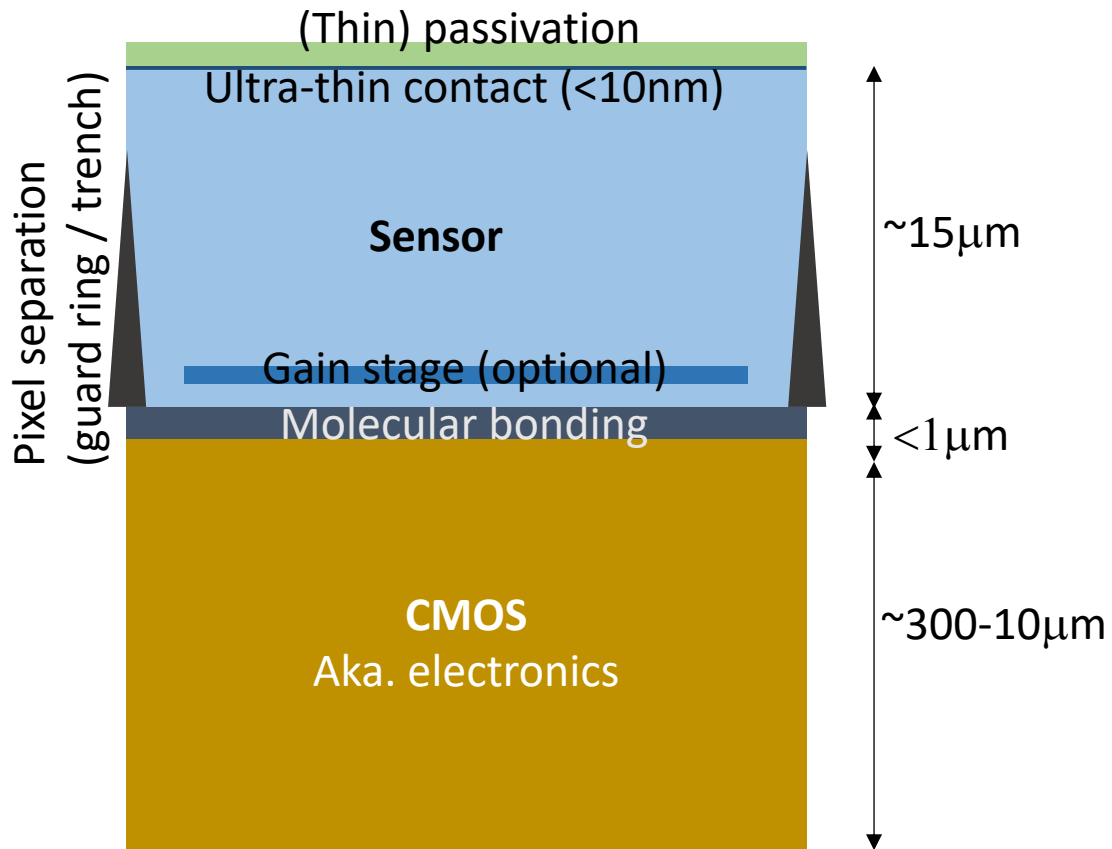
- Essentially identical constraints to VUV photon detections
  - Limit material in path of photo-electron
  - Charge collection very close to surface

# Hybrid solution for tracking



- Low Gain Avalanche diode for future colliders
  - Expected to be radiation hard
- Advantages for nuclear physics
  - Very thin
  - Timing resolution < 100ps

# Back-side illuminated concept



- TRIUMF working on BSI design
  - Especially managing light emission during avalanche
- Manufacturing

# From sensor to module

